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DMT10H015LCG

100V N-CHANNEL ENHANCEMENT MODE MOSFET

100% Unclamped Inductive Switch (UIS) Test in Production

Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2) Halogen and Antimony Free. "Green" Device (Note 3)

Case Material: Molded Plastic, "Green" Molding Compound.

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C
100\/	15mΩ @ V _{GS} = 10V	34A
100V	19.5mΩ @ V _{GS} = 6V	32A

Description and Applications

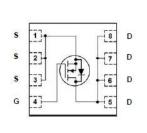
This new generation N-Channel Enhancement Mode MOSFET is designed to minimize $R_{\text{DS}(\text{ON})}$ and yet maintain superior switching performance. This device is ideal for use in Notebook battery power management and Load switch.

- Backlighting
- Power Management Functions
- DC-DC Converters

Pin 1 S S S O D D D D D

Top View

Bottom View



Features and Benefits

High Conversion Efficiency

Case: V-DFN3333-8 (Type B)

Weight: 0.03 grams (Approximate)

Low Input Capacitance Fast Switching Speed

Mechanical Data

Low R_{DS(ON)} – Minimizes On State Losses

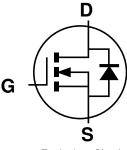
UL Flammability Classification Rating 94V-0

Moisture Sensitivity: Level 1 per J-STD-020 Terminal Connections Indicator: See Below Diagram

Solderable per MIL-STD-202, Method 208 @

Terminals: Finish -NiPdAu over Copper Leadframe.

Top View Internal Schematic



Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Packaging
DMT10H015LCG-7	V-DFN3333-8 (Type B)	2,000/Tape & Reel
DMT10H015LCG-13	V-DFN3333-8 (Type B)	3,000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

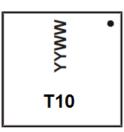
 See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

Notes:



T10 = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 18 = 2018) WW = Week (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	100	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current, V_{GS} = 10V (Note 6)	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	9.4 7.5	А
Continuous Drain Current, V _{GS} = 10V	Steady State	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$	ID	34 21	А
Maximum Continuous Body Diode Forward Current (Note 6)			Is	1.6	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	54	А
Avalanche Current, L = 3mH (Note 8)			I _{AS}	7.5	А
Avalanche Energy, L = 3mH (Note 8)			E _{AS}	85	mJ

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	1	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ extsf{ heta}JA}$	118	°C/W
Total Power Dissipation (Note 6)	PD	2.1	W
Thermal Resistance, Junction to Ambient (Note 6)	R ₀ JA	59	°C/W
Thermal Resistance, Junction to Case	R _{0JC}	4.5	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)	- C J 2 Cl				•		
Drain-Source Breakdown Voltage	BV _{DSS}	100	_	_	V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μA	$V_{DS} = 80V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	1.4	2	3.5	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
		—	12.1	15	mΩ	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	—	15	19.5	11122	$V_{GS} = 6V, I_D = 20A$	
		—	18.9	26	mΩ	$V_{GS} = 4.5V, I_D = 5A$	
Diode Forward Voltage	V _{SD}	—	0.9	1.3	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 8)					-		
Input Capacitance	Ciss		1871	—		$V_{DS} = 50V, V_{GS} = 0V$ f = 1MHz	
Output Capacitance	Coss	—	261	—	pF		
Reverse Transfer Capacitance	Crss	_	6.9	—			
Gate Resistance	Rg	_	0.75	—	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	_	33.3	_			
Gate-Source Charge	Qgs	_	6.9	-	nC	$V_{DD} = 50V, I_D = 10A,$ $V_{GS} = 10V$	
Gate-Drain Charge	Q _{gd}	_	5.1	_		$v_{GS} = 10v$	
Turn-On Delay Time	t _{D(ON)}	_	6.5	_			
Turn-On Rise Time	t _R	_	7	_		$V_{DD} = 50V, V_{GS} = 10V,$	
Turn-Off Delay Time	t _{D(OFF)}	_	19.7	—	ns	$I_D = 10A, R_g = 6\Omega$	
Turn-Off Fall Time	tF	_	8.1	_		-	
Reverse Recovery Time	t _{RR}	_	37.9	—	ns		
Reverse Recovery Charge	Q _{RR}	_	51.9	—	nC	I _F = 10A, di/dt = 100A/μs	

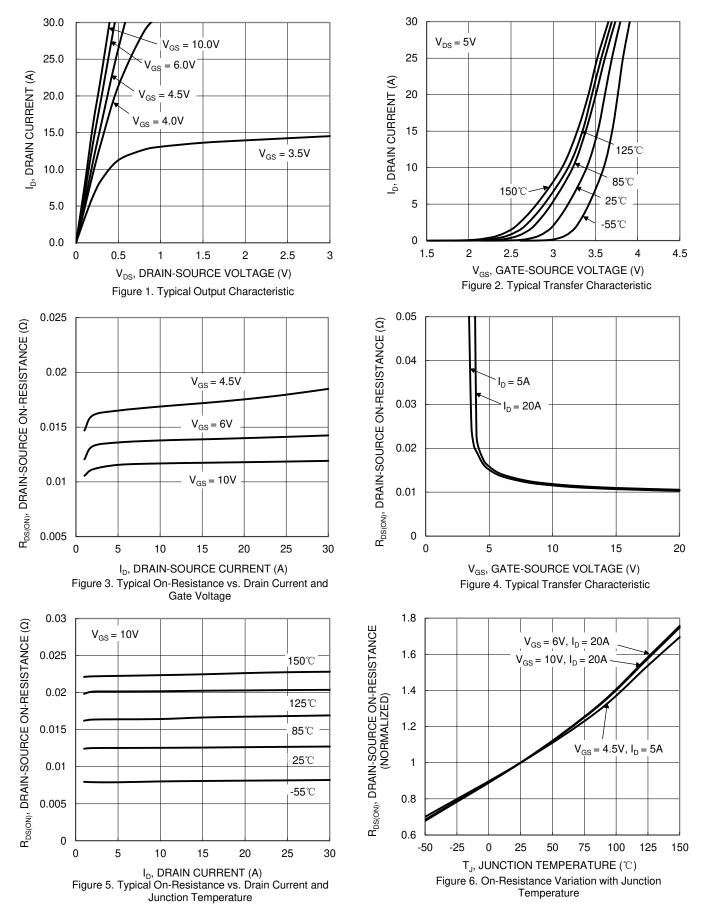
5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. Notes:

7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing



DMT10H015LCG





125

150

 $I_D = 1mA$

 $I_{D} = 250 \mu A$

25

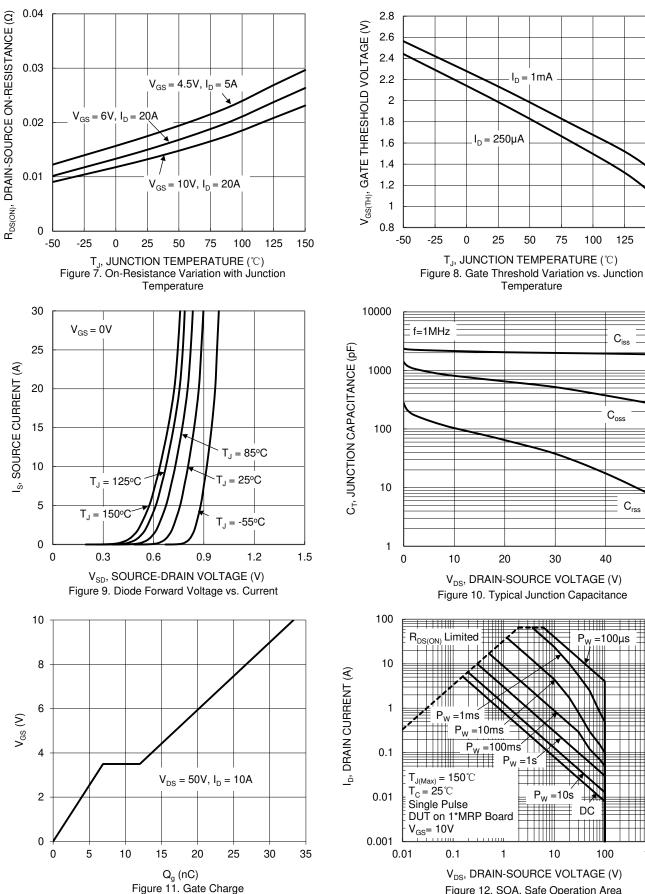
50

Temperature

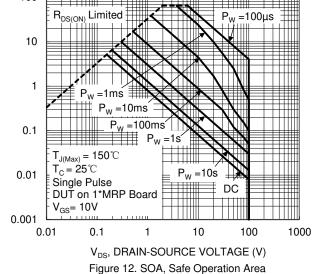
75

100

0

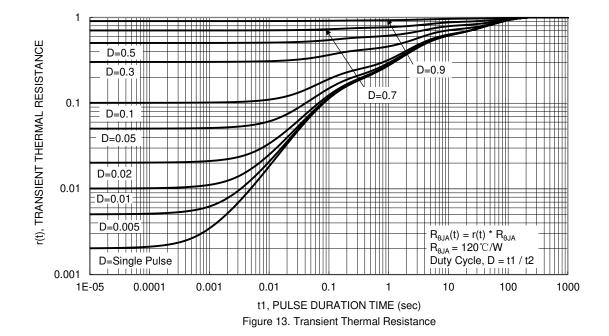


Ciss C_{oss} C_{rss} 10 20 30 40 50 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 10. Typical Junction Capacitance



DMT10H015LCG Document number: DS38362 Rev. 4 - 2

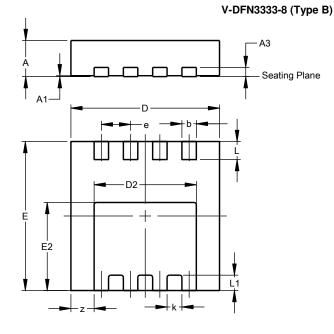






Package Outline Dimensions

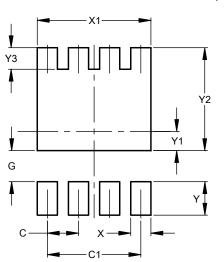
Please see http://www.diodes.com/package-outlines.html for the latest version.



V-DFN3333-8						
	(Type B)					
Dim	Min	Max	Тур			
Α	0.75	0.85	0.80			
A1	0.00	0.05	0.02			
A3			0.203			
b	0.27	0.37	0.32			
D	3.25	3.35	3.30			
D2	2.17	2.37	2.27			
Е	3.25	3.35	3.30			
E2	1.85	2.05	1.95			
е			0.65			
k			0.33			
L	0.35	0.45	0.40			
L1			0.34			
z			0.515			
All	All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



V-DFN3333-8 (Type B)

Dimensions	Value (in mm)			
С	0.650			
C1	1.950			
G	0.650			
X	0.420			
X1	2.370			
Y	0.700			
Y1	0.400			
Y2	2.150			
Y3	0.450			



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